





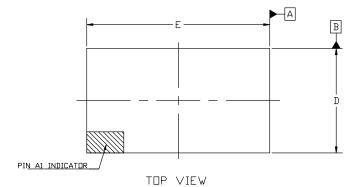
SIP49 3.00x5.25 CASE 127FH **ISSUE A**

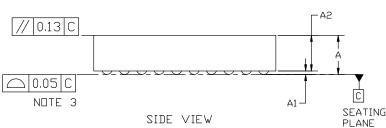
DATE 02 JUN 2023

- Ø0.250

PACKAGE

DUTLINE



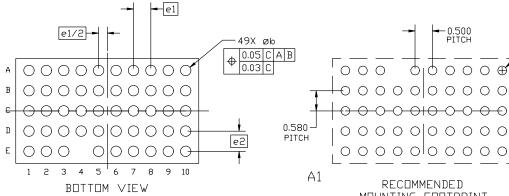


NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS
- COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE PADS.

	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α			1.275	
A1	0.050	0.100	0.150	
A2	0.925	1.025	1.125	
b	0.250	0.300	0.350	
D	2.875	3.000	3.125	
E	5.125	5.250	5.375	
e1	0.500 BSC			
e2	0.580 BSC			

010000 Q



RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

GENERIC MARKING DIAGRAM*

XXXXXXXXXXX ZZZZZZ NNNNN

XXXX = Specific Device Code ZZZ = Assembly Lot Code NNN = Serial Number

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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